

In re PATENT application of:

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Shunpei YAMAZAKIet al.

Examiner: Asok SARKAR

Art Unit:

Application No.:

09/699,466

Filed:

October 31, 2000

For:

METHOD FOR FABRICATING

A SEMICONDUCTOR DEVICE

CERTIFICATE OF MAILING

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D.C. 20231, on 7-3-01.

AMENDMENT

Commissioner of Patents Washington, D.C. 20231

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July 5, 2001

Dear Sir:

V55531182

In response to the Examiner's non-Final Office Action mailed April 5 2001, please consider the following amendments and remarks in connection with the above-identified application.

REMARKS

At the outset, the Examiner is thanked for the thorough review and consideration of the present application.

The Examiner's Office Action dated April 5, 2001, has been received and its contents reviewed. Claims 1-25 were pending in the present application, of which claims 1, 4, 7, 11, 15, and 20 are independent.

Referring now to the Office Action, claims 1 and 2 are rejected under 35 U.S.C. \$103(a) as being unpatentable over Biegesen et al. (U.S. Patent No. 4,330,363) in view of Ham et al. (U.S. Patent No. 3,890,632). Claims 4, 5, 7, 8, 10-12, 14-16, 18-21, 23, and 25 are rejected as being unpatentable over Biegesen et al. (U.S. Patent No. 4,330,363) and Funai et al. (U.S. Patent No. 5,550,070) in view of Ham et al. Claims 3, 6, 9, 13, 17, and 22 are rejected as being unpatentable over Biegesen et al. (U.S. Patent No. 4,330,363) and Funai et al. in view of Ham et al. as applied to claims 1, 4, 7, 11, 15 and 20 above, and further in view